CHIPQUIK®

SMD2SWLT.047 20Z

Datasheet revision 1.1 www.chipquik.com

Sn42/Bi57.6/Ag0.4 .047" Solid Core Solder Wire 2oz Spool

Product Highlights LOW TEMPERATURE Melts at 138°C (281°F) Lead-Free RoHS 3 and REACH compliant

Specifications

Alloy: Sn42/Bi57.6/Ag0.4
Wire diameter: 0.047" (1.2mm)
Melting Point: 138°C (281°F)
Packaging: 2oz Spool
Shelf Life: >60 months



Storage and Handling

Store in a non-corrosive, dry environment.

Please Note: Although Sn42/Bi57.6/Ag0.4 forms strong joints and is more ductile due to the added 0.4% Silver, in wire form it is brittle and needs to be handled gently when unspooling. It is normal for spooled Sn42/Bi57.6/Ag0.4 wire to have some breaks in it.

Test Results

| Test J-STD-004 or other requirements as stated | Test Requirement | Result |
|--|---|--|
| Conflict Minerals Compliance | Electronic Industry Citizenship Coalition (EICC) | Compliant |
| REACH Compliance | Articles 33 and 67 of Regulation (EC) No 1907/2006 | Contains no substance >0.1% w/w that is listed as a SVHC or restricted for use in solder materials |

Conforms to the following Industry Standards:

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders): Yes RoHS 3 Directive (EU) 2015/863: Yes